# onsemi

# Switch-mode Power Rectifier

45 V, 40 A

# MBR40L45CTG, NRVBB40L45CTT4G

### Features and Benefits

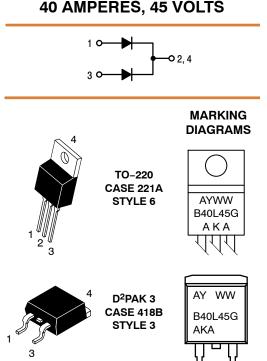
- Low Forward Voltage
- Low Power Loss/High Efficiency
- High Surge Capacity
- 175°C Operating Junction Temperature
- 40 A Total (20 A Per Diode Leg)
- Guard-Ring for Stress Protection
- NRVBB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

### Applications

- Power Supply Output Rectification
- Power Management
- Instrumentation

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight (Approximately): 1.9 Grams (TO-220)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 Units Per Plastic Tube for TO-220



SCHOTTKY BARRIER

RECTIFIERS

B40L45 A Y	= Device Code = Assembly Location = Year
WW	= Work Week
G	= Pb-Free Device
AKA	= Polarity Designator

## **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MBR40L45CTG	TO-220 (Pb-Free)	50 Units/Rail
NRVBB40L45CTT4G	D <sup>2</sup> PAK 3 (Pb–Free)	800 /Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

# MBR40L45CTG, NRVBB40L45CTT4G

#### MAXIMUM RATINGS (Per Diode Leg)

Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	45	V	
Average Rectified Forward Current (Rated $V_R$ ) $T_C$ = 145°C	I <sub>F(AV)</sub>	20	A	
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz)	I <sub>FRM</sub>	40	A	
Non-repetitive Peak Surge Current (Surge applied at rated load conditions half-wave, single phase, 60 Hz)	I <sub>FSM</sub>	200	A	
Operating Junction Temperature (Note 1)	TJ	-65 to +175	°C	
Storage Temperature	T <sub>stg</sub>	-65 to +175	°C	
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000	V/μs	
ESD Ratings: Machine Model = C Human Body Model = 3B		> 400 > 8000	V	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The heat generated must be less than the thermal conductivity from Junction-to-Ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ .

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Junction-to-Case Junction-to-Ambient	${f R}_{ heta JC} {f R}_{ heta JA}$	1.9 72.9	°C/W

#### ELECTRICAL CHARACTERISTICS (Per Diode Leg)

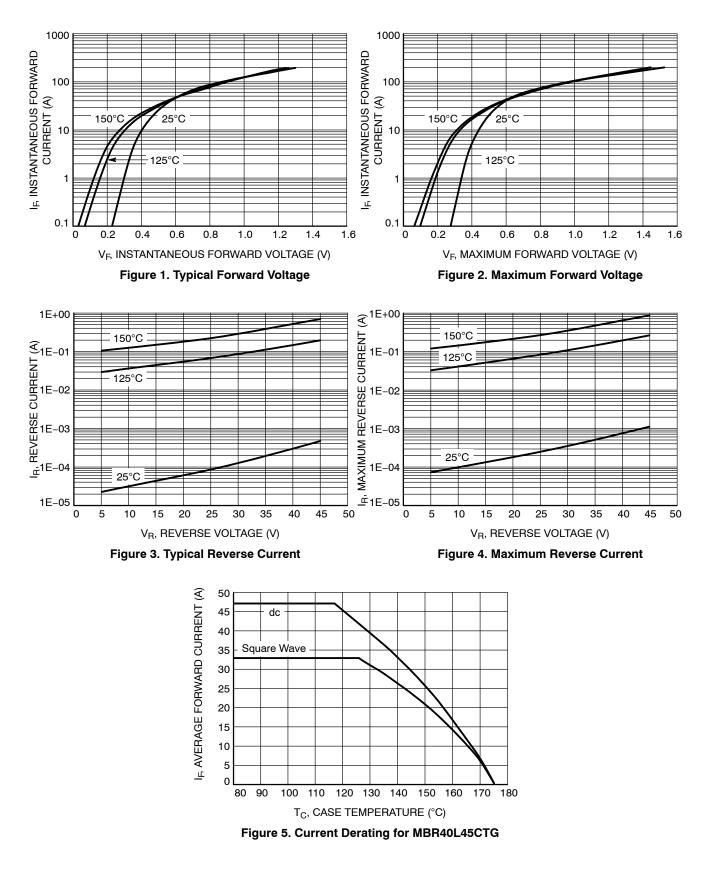
Characteristic	Symbol	Value	Unit
	VF	0.50 0.48 0.63 0.68	V
Maximum Instantaneous Reverse Current (Note 2) (Rated DC Voltage, $T_C = 25^{\circ}C$ ) (Rated DC Voltage, $T_C = 125^{\circ}C$ )	İR	1.2 275	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$ 2.0%.

# MBR40L45CTG, NRVBB40L45CTT4G

# **TYPICAL CHARACTERISTICS**



# MBR40L45CTG, NRVBB40L45CTT4G

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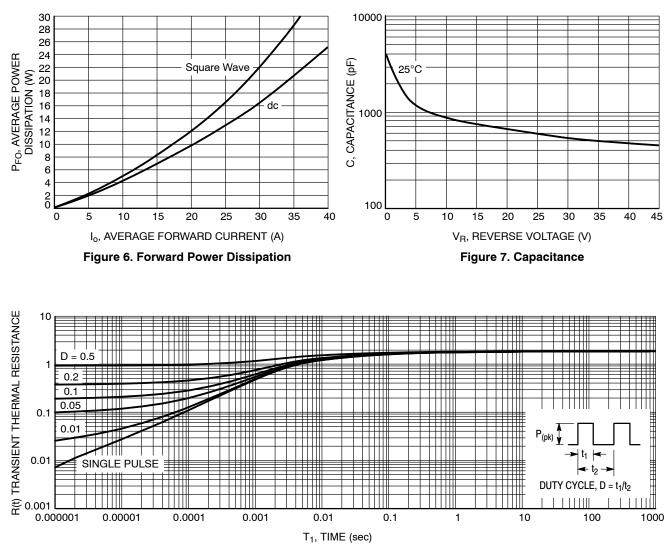


Figure 8. Thermal Response Junction-to-Case for MBR40L45CTG

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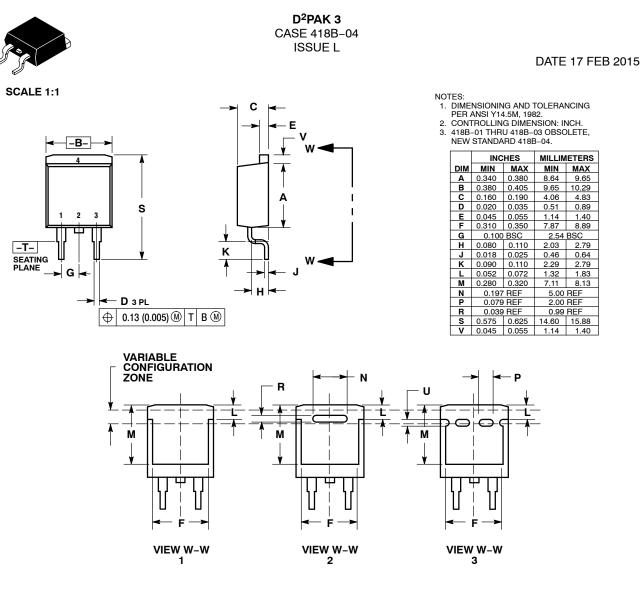
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SCALE 1:1		PLANE 1 2 3.	. CONT . DIMEI LEA	ROLLING D NSION Z DE D IRREGUL/ WIDTH FOR	AND TOLERAI IMENSION: IN FINES A ZONI ARITIES ARE A F102 DEVICE	NCHES E WHERE AL ALLOWED. E = 1.35MM	L BODY AND	
A A				INC	1	MILLIM		
	Ŭ		DIM	MIN.	MAX.	MIN.	MAX.	
1 2 3			A	0.570	0.620	14.48	15.75	
			B	0.380	0.415	9.66	10.53	
<u>₩ —</u> ₩₩₩₩ Ĭ			C D	0.160	0.190	4.07	4.83	
			F	0.025	0.038	0.64 3.60	0.96 4.09	
Z-J K			G	0.095	0.101	2.42	2.66	
			н	0.110	0.103	2.42	4.10	
				0.014	0.024	0.36	0.61	
			ĸ	0.500	0.562	12.70	14.27	
∨4	R —		L	0.045	0.060	1.15	1.52	
G	J <del>→    →</del>		N	0.190	0.210	4.83	5.33	
→ <b>→</b> D			Q	0.100	0.120	2.54	3.04	
N			R	0.080	0.110	2.04	2.79	
			s	0.045	0.055	1.15	1.41	
			т	0.235	0.255	5.97	6.47	
			U	0.000	0.050	0.00	1.27	
			V	0.045		1.15		
			Z		0.080		2.04	
STYLE 1: PIN 1. BASE 2. COLLECTOR 3. EMITTER 4. COLLECTOR	STYLE 2: PIN 1. BASE 2. EMITTER 3. COLLECTOR 4. EMITTER	3. 0	CATHODI NODE GATE NODE		2. MA 3. GA	in terminal In terminal Te In terminal	.2	
STYLE 5: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN	STYLE 6: PIN 1. ANODE 2. CATHODE 3. ANODE 4. CATHODE	3. 0	Cathodi Node Cathodi Node	E	STYLE 8: PIN 1. CA 2. AN 3. EX 4. AN	ode Ternal Trip	/DELAY	
STYLE 9: PIN 1. GATE 2. COLLECTOR 3. EMITTER 4. COLLECTOR	STYLE 10: PIN 1. GATE 2. SOURCE 3. DRAIN 4. SOURCE	3. 0	OURCE		2. MA 3. GA	NIN TERMINAL NIN TERMINAL TE NT CONNECTI	.2	

 
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STYLE 1:	STYLE 2:	STYLE 3:	STYLE 4:	STYLE 5:	STYLE 6:
PIN 1. BASE	PIN 1. GATE	PIN 1. ANODE	PIN 1. GATE	PIN 1. CATHODE	PIN 1. NO CONNECT
2. COLLECTOR	2. DRAIN	2. CATHODE	2. COLLECTOR	2. ANODE	2. CATHODE
3. EMITTER	<ol><li>SOURCE</li></ol>	<ol><li>ANODE</li></ol>	3. EMITTER	<ol><li>CATHODE</li></ol>	3. ANODE
4. COLLECTOR	4. DRAIN	4. CATHODE	4. COLLECTOR	4. ANODE	4. CATHODE

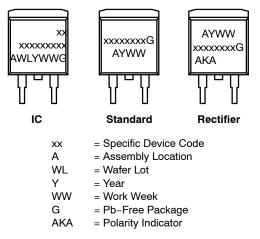
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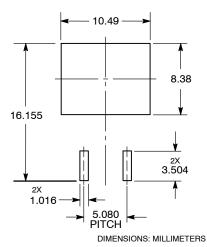
#### DATE 17 FEB 2015

#### GENERIC MARKING DIAGRAM\*



\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present.

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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